05-22-2002

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Atty. Docket No. JP920010051US1

R SHEET

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1. Name of conveying party(ies): Kentaro Sugiyama Atsushi Abe *5·13·02* Additional name(s) of conveying party(ies) attached? ___ Yes _X_ No	2. Name and address of receiving party(ies): Name: International Business Machines Corporation Address: New Orchard Road Armonk, NY 10504 Additional name(s) & addresses attached? ___ Yes _X_ No
3. Nature of conveyance: X Assignment Execution Date(s): March 18, 2002, March 18, 2002.	4. Patent Application number(s) 10/063,048 Execution Date(s): March 18, 2002, March 18, 2002.
5. Name and address of party to whom correspondence concerning document should be mailed: Name: Derek S. Jennings Address: IBM Corporation Intellectual Property Law Dept. P.O. Box 218 Yorktown Heights, NY 10598	6. Total number of applications involved: 1 7. Total fee (37 CFR 3.41): $40.00 X Charge to Deposit Account No.: 09-0468

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05/21/2002 TDIAZ1   00000110 090468   10063048
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PATENT
REEL: 012903 FRAME: 0438

Assignment

Whereas, we

**INVENTOR
AND CITY**

(1) Kentaro Sugiyama   of 3-33-18 Ryokuen, Izumi-ku,
Yokohama-shi, Kanagawa-ken,   Japan

**INVENTOR
AND CITY**

(2) Atsushi Abe   of 48-9-201 Shiratori-dai, Aoba-ku,
Yokohama-shi, Kanagawa-ken,   Japan

have invented certain improvements in

TITLE   NON-DESTRUCTIVE PROBING SYSTEM AND A METHOD THEREOF

and executed, respectively, a United States patent application therefor on

DATES THAT   (1) *March, 18,*   2002, and (2)   *March, 18,* 2002.
**INVENTORS
SIGNED THE
DECLARATION**

Whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we, the above named, hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said applications to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

Signed and sealed

CITY AND   (1) at *Yamato*
DATE   on *March, 18,* 2002,   *Kentaro Sugiyama* _____ SIGNATURE
                                        (Kentaro   Sugiyama) INVENTOR
                                        FIRST NAME   MIDDLE INITIAL   LAST NAME

CITY AND   (2) at *Yamato*
DATE   on *March, 18,* 2002,   *Atsushi Abe* _____ SIGNATURE
                                        (Atsushi   Abe   ) INVENTOR
                                        FIRST NAME   MIDDLE INITIAL   LAST NAME